

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT6121766

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MIN WANG	02/11/2020
YUDONG CHEN	02/11/2020
DEKAI LI	02/11/2020
LI LI	02/11/2020
JINDONG ZHANG	02/11/2020
BO PANG	02/11/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	TENCENT TECHNOLOGY (SHENZHEN) COMPANY LIMITED
<b>Street Address:</b>	35/F, TENCENT BUILDING, KEJIZHONGYI ROAD
<b>Internal Address:</b>	MIDWEST DISTRICT OF HI-TECH PARK, NANSHAN DISTRICT
<b>City:</b>	SHENZHEN, GUANGDONG
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	518057
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16799652
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	031384-5936-US
<b>NAME OF SUBMITTER:</b>	YALEI SUN
<b>SIGNATURE:</b>	/Yalei Sun/
<b>DATE SIGNED:</b>	05/26/2020

**Total Attachments: 2**

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## ASSIGNMENT

WHEREAS, WE, **Min WANG**, citizen of China, residing in Shenzhen, CN; **Yudong CHEN**, citizen of China, residing in Shenzhen, CN; **Dekai LI**, citizen of China, residing in Shenzhen, CN; **Li LI**, citizen of China, residing in Shenzhen, CN; **Jindong ZHANG**, citizen of China, residing in Shenzhen, CN; and **Bo PANG**, citizen of China, residing in Shenzhen, CN, ASSIGNORS, are the inventors of the invention in **RESOURCE SCHEDULING METHOD, SCHEDULING SERVER, CLOUD COMPUTING SYSTEM, AND STORAGE MEDIUM**, described in an application for a Patent of the United States

- which is executed on  even date herewith
- which is identified by Morgan, Lewis & Bockius LLP docket no. 031384-5936-US
- which was filed on \_\_\_\_\_, Application No. \_\_\_\_\_
- which claims priority on U.S. Provisional Patent Application No(s). \_\_\_\_\_
- We hereby authorize and request our attorney, **Yafei Sun**, of Morgan, Lewis & Bockius LLP, to insert here in parenthesis (Application number 16/799,652, filed February 24, 2020) the filing date and application number of said application when known.

and WHEREAS, **TENCENT TECHNOLOGY (SHENZHEN) COMPANY LIMITED**, ASSIGNEE, having a place of business at 35/F, Tencent Building, Kejizhongyi Road, Midwest District of Hi-tech Park, Nanshan District, Shenzhen, Guangdong, P. R. China 518057, is desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, let it be known that for and in consideration of the sum of One Dollar (\$1.00) to me paid, and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, we, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, our entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and any substitute applications therefore, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof, the said United States provisional patent application(s), if any, on which the said United States application claims priority; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may hereafter be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application and said United States provisional patent application(s), if any, under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof;

AND WE HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

IN TESTIMONY WHEREOF, We hereunto set our hands and seals the day and year set opposite our respective signatures.

Date 2020.02.11

Min WANG L.S.  
Min WANG

Date 2020.02.11

Yudong CHEN L.S.  
Yudong CHEN

Date 2020.02.11

Dehai LI L.S.  
Dehai LI

Date 2020.02.11

Li LI L.S.  
Li LI

Date 2020.02.11

Jindong ZHANG L.S.  
Jindong ZHANG

Date 2020.02.11

Bo PANG L.S.  
Bo PANG